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(54) **Image pickup device**

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Dispositif de prise d'image

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(73) Proprietor: **CANON KABUSHIKI KAISHA**  
**Tokyo (JP)**

(72) Inventor: **Yushiya, Akihiko, c/o Canon K.K.**  
**Tokyo (JP)**

(74) Representative:  
**Beresford, Keith Denis Lewis et al**  
**BERESFORD & Co.**  
**High Holborn**  
**2-5 Warwick Court**  
**London WC1R 5DJ (GB)**

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## Description

### BACKGROUND OF THE INVENTION

#### Field of the Invention

[0001] The present invention relates to an image pick-up device for picking up the image of an object and converting it into an image signal.

#### Related Background Art

[0002] As an image sensor for reading an original document, there is already known a contact multi-chip image sensor, composed of a light source, a short-focus imaging element array and plural line sensors. Figs. 1 to 4 illustrate an example of such image pickup device. Referring to Fig. 1, at the upper end of a frame 200, there is provided a transparent glass plate 201 capable of contacting an original document. Illuminating light 212, emitted from a light source 210 provided in the frame 200, illuminates the surface of the original document contacting the upper face of the transparent glass plate 201. The light 213 reflected from the original is transmitted through an optical system 209 and an infrared cut-off filter 211 and is focused on a sensor array 1 provided on a substrate 19, corresponding to the optical system 209.

[0003] The above-mentioned optical system is composed, for example, of an array of imaging elements of a short focal length, such as Selfoc lens array (trade name of Japan Plate Glass Co., Ltd.). Also the above-mentioned light source is composed of a xenon tube or a cold cathode tube.

[0004] The sensor array 1 is constructed in the following manner. As shown in Fig. 2, the sensor array 1 is composed of a linear array of plural sensor chips 2, 2', 2'', ... on the substrate 19, and is covered by a protective film 206. The substrate 19 is supported by a bottom plate 205 engaging with the frame 200 as shown in Fig. 1, and is connected to a flexible circuit board 203 through a flexible cable 208. The flexible board 203 is provided thereon with a connector 202 for the input/output of power supply and control signals, and the connector 202 is mounted, as shown in Fig. 3, on the frame 200 with screws 207.

[0005] Fig. 4 shows the pixel arrangement in the vicinity of joints of the plural sensor chips 2, 2', 2'', ... arranged linearly on the substrate 19 constituting the sensor array 1. R, G and B pixels 3, 4, 5, respectively covered by R, G and B color filters are arranged in succession, with element isolation areas 6 therebetween, and these pixels release mutually independent signals. In the signal processing, the consecutive R, G and B pixels are regarded to constitute a picture element, and the output signals of the R, G, B pixels are regarded as R, G, B components of the picture element. Such arrangement enables image reading with a high resolution.

[0006] In the following there will be briefly explained the color reproduction of a color original, utilizing the contact multi-chip color image sensor of the above-explained configuration. Fig. 5 shows a CIE-xy chromaticity diagram, in which an area surrounded by a solid line, consisting of a spectrum line and a red-purple line, includes all the colors. Fig. 6 shows the spectral sensitivity distribution of the R, G and B sensor in the contact multi-chip color image sensor, Fig. 13 shows spectral emission characteristics of an Xe tube, Fig 14 shows spectral transmission characteristics of an infrared cut-off filter and the chromaticity coordinates R, G, B of the sensors can be determined from Figs. 6, 13 and 14. An area inside a broken-lined triangle, having the corner points at the chromaticity ordinates R, G, B, indicates the color reproduction area of the contact multi-chip color image sensor.

[0007] If R, G, B signals  $r, g, b$  are obtained in a picture element by reading an original document, the color of the original is represented by the coordinate of the center of gravity when the  $r, g, b$  values are respectively placed at the points R, G, B in Fig. 5. As an example, if the original document is the white reference, there stands a relation  $r = g = b$ , so that the color of the white reference is represented by the coordinate of the center of gravity of the triangle RGB, representing the color reproducible area of the contact multi-chip color image sensor. Similarly the colors of the picture elements present in the original can be determined and the color reproduction can be achieved with R, G, B colors.

[0008] In the following there will be explained the method of representing the resolution of an image. There are known various methods for representing the resolution, but, in the following, explained is a method utilizing MTF. By reading a grid pattern as shown in Fig. 7 with an image sensor, there is obtained an output signal as shown in Fig. 8. The modulation transfer function (MTF) can be obtained by substituting the maximum value  $i_{\max}$  and the minimum value  $i_{\min}$  of such output signal into the following equation:

$$\text{MTF} = (i_{\max} - i_{\min}) / (i_{\max} + i_{\min}) \times 100 (\%)$$

[0009] As the MTF of the sensor chip is generally sufficiently high, the MTF of the Selfoc lens array (SLA) used in the optical system is directly reflected in the MTF of the image sensor. Fig. 9 shows an example of the spatial frequency characteristics of such MTF.

[0010] For example, in case of an image sensor with a resolution of 400 DPI and with a conventional pixel arrangement as shown in Fig. 4, the pitch of the picture elements is equal to about  $63.5 \mu\text{m}$ , while the distance between the pixels R and G or G and B constituting a picture element is about  $21.2 \mu\text{m}$ , and that between the pixels R and B is about  $42.3 \mu\text{m}$ . With such distances among the pixels, the optical system 209 has a resolution of about 8  $\ell\text{p/mm}$  between the picture elements, 24

$\ell$ p/mm between the pixels R and G or G and B, and 12  $\ell$ p/mm between the pixels R and B. According to Fig. 9, the MTF of the optical system is sufficiently low, about 0 %, for a distance between the pixels R and G or G and B, but is about 30 % at a distance between the pixels R and B, corresponding to a considerable resolving power which is no longer negligible in comparison with the MTF of 50 % between the picture elements. Thus, if the optical system resolves the image light among the pixels constituting the picture element, there tend to be generated colored moirée fringes because of the difference in the optical positions, and there is provided a very unpleasant image particularly in case of a monochromatic image because of generation of false colors at the edge portion between black and white areas.

[0011] Such false color generation may be suppressed by reducing such colored moirée fringes for example through a signal processing so as to align the reading positions of the R, G, B pixels utilizing the outputs of the mutually adjacent pixels of a same color, but such method results in an increase in the circuit magnitude, because of the necessity for a memory for correcting the reading position, thus leading to an increased cost. Also the correction by such circuit alone cannot completely avoid the generation of such colored moirée fringes or false colors.

[0012] Also in case the sensor array is constituted by plural sensor chips, the spectral sensitivity characteristics may be different among such sensor chips, and the color space, constituting the basis of color reproduction, also becomes different among such sensor chips. For this reason, there may result an unnatural step difference in color, in the original image reading at the junction between the sensor chips. Particularly in case of an original which has a uniform color area over several sensor chips, there is reproduced a very unpleasant image with conspicuous streaks of color step difference.

#### SUMMARY OF THE INVENTION

[0013] A concern of the present invention is to provide an image pickup device capable of image taking of high quality.

[0014] Another concern of the present invention is to provide an image pickup device with an improved sensitivity.

[0015] Still another concern of the present invention is to provide an image pickup device free from generation of colored moirée fringes, false colors or color step difference.

[0016] United States Patent Specification No US-A-4870483 discloses a colour image sensor having a plurality of aligned sensor parts, each sensor part comprising a plurality of sensor chips which are arranged in a line and associated with different colour filters.

[0017] In accordance with the present invention, there is provided an image sensor as set out in claim 1.

[0018] It is thus rendered possible to provide an image

pickup device capable of image taking of high quality, also to provide an image pickup device of an improved sensitivity, and to provide an image pickup device free from generation of colored moirée fringes, false colors and color step difference.

[0019] Still other features of the present invention will become fully apparent from the following description, which is to be taken in conjunction with the attached drawings.

#### BRIEF DESCRIPTION OF THE DRAWINGS

[0020]

Fig. 1 is a cross-sectional view of a contact multi-chip image sensor utilizing Xe tube as a light source;

Fig. 2 is a plan view of a sensor array;

Fig. 3 is an external perspective view of a contact multi-chip image sensor;

Fig. 4 is a view showing the arrangement of pixels in a conventional sensor chip;

Fig. 5 is an x-y chromaticity diagram of a sensor;

Fig. 6 is a chart showing spectral sensitivity characteristics of R, G, B sensors;

Fig. 7 is a chart showing a grid pattern for MTF measurement; Fig. 8 is a chart showing the output signal wave form of an image sensor at the MTF measurement;

Fig. 9 is a chart showing an example of MTF characteristics;

Fig. 10 is a view showing the pixel arrangement in sensor chips in a first embodiment;

Fig. 11 is an x-y chromaticity diagram of green sensors in a second embodiment;

Fig. 12 is a chart showing the spectral sensitivity characteristics of green sensors in the second embodiment;

Fig. 13 is a chart showing the spectral emission characteristics of an Xe tube in the second embodiment;

Fig. 14 is a chart showing the spectral transmission characteristics of an infrared cut-off filter in the second embodiment;

Fig. 15 is an x-y chromaticity diagram of sensor chips in the second embodiment;

Fig. 16 is a chart showing grouping ranges in the second embodiment;

Fig. 17 is a chart showing grouping by x-y chromaticity of B sensors in the second embodiment;

Fig. 18 is a chart showing grouping by x-y chromaticity of R sensors in the second embodiment;

Fig. 19 is a cross-sectional view of a contact multi-chip image sensor of a third embodiment;

Fig. 20 is a view of an LED board in the third embodiment;

Fig. 21 is a view showing the arrangement of pixels in the sensor chips of the third embodiment;

Fig. 22 is a chart showing the spectral sensitivity characteristics of sensor chip; and

Fig. 23 is a chart showing the spectral emission characteristics of LED's of R, G, B in the third embodiment.

#### DESCRIPTION OF THE PREFERRED EMBODIMENTS

[0021] Fig. 10 is a view showing the configuration of an image sensor constituting a first embodiment of the present invention. The image sensor of the present embodiment is a multi-chip image sensor in which a sensor array is composed of plural sensor chips wherein three pixels (R, G and B) constituting a picture element are arranged in the main scanning direction, which is the longitudinal direction of the image sensor, and a pixel separating area (light shielding area) is provided between the picture elements.

[0022] The basic structure of the image pickup device is same, also in case of the image sensor of the present embodiment, as that shown in Fig. 1 and will not, therefore, be explained further.

[0023] In the image sensor shown in Fig. 10, the pitch between the centers of the mutually adjacent picture elements is about 63.5  $\mu\text{m}$ , but, because of the presence of a light shielding area 7 between the picture elements, the pitch of the pixels R and G or G and B within a picture element is about 15.0  $\mu\text{m}$  and that of the pixels R and B is about 30.0  $\mu\text{m}$ . With such positional arrangement, the optical system 209 has a resolution of 8  $\ell\text{p/mm}$  between the picture elements, 32  $\ell\text{p/mm}$  between the pixels R-G or G-B and 16  $\ell\text{p/mm}$  between the pixels R-B. Thus, according to Fig. 9, the MTF value is about 50 % between the picture elements, about 0 % between the pixels R-G, G-B or R-B and about 10 % between the pixels R-B.

[0024] As explained in the foregoing, in the image sensor, it is desired that the MTF characteristics of the optical system have a high resolution among the picture elements and a low resolution between the pixels R-G, G-B or R-B constituting a picture element. The pixel arrangement of the present embodiment allows to reduce the resolution between the pixels R-G, G-B or R-B constituting a picture element, while maintaining the resolution between the picture elements, thereby optically reducing the colored moiree fringes and providing an image of high quality without the addition of a particular signal processing circuit.

[0025] Also the pixel arrangement of the present embodiment can resolve the moiree fringes, resulting from the joint of the sensor chips, in addition to the suppression of the resolution among the R, G, B pixels within each picture element. Besides the reading sensitivity can be improved as the area of aperture within each picture element can be increased.

[0026] As explained in the foregoing, the image pickup device of the present embodiment is provided with

an image sensor for receiving the light from an object and converting the light into an electrical signal, and an optical system for focusing the image light from the object onto the image sensor, wherein, in the image sensor, plural pixels for different colors are arranged along the main scanning direction to constitute a picture element and a pixel separating area is provided between the adjacent picture elements, in which the picture elements are arranged with a pitch resolvable by the optical system while the pixels constituting each picture element are arranged with such a pitch that lowers the resolution by the optical system. Such configuration enables to optically prevent the colored moiree fringes, thus avoiding generation of unpleasant false colors for example at the edge portions of a black-and-white image. It is also rendered possible to achieve high-quality image reading with the image sensor, without increase in the circuit magnitude or in the memory capacity. It is furthermore rendered possible to achieve image taking of high quality, without increase in cost, by the image pickup device utilizing such image sensor.

[0027] The image sensor of the present embodiment is composed of R, G and B pixels, but it may also be composed of pixels of other colors, for example yellow, magenta and cyan.

[0028] Also the order of arrangement of these colors is not limited to the example of the present embodiment.

[0029] Fig. 11 is a CIE-xy chromaticity diagram, similar to Fig. 5, showing the grouped spectral sensitivity characteristics of sensor chips in a second embodiment. In Fig. 11, each plot represents the x-y chromaticity of G sensors of 10 chips. In the contact multi-chip color image sensor of the present embodiment, the x-y chromaticity of the G sensor can be determined from the following calculation. From the spectral characteristics of the constituents, the tristimulus values Xg, Yg, Zg of the G sensor in the CIE 1931 standard colorimetric system are given by:

$$X_g = K \int X_e(\lambda) I_R(\lambda) S_G(\lambda) x(\lambda) d\lambda$$

$$Y_g = K \int X_e(\lambda) I_R(\lambda) S_G(\lambda) y(\lambda) d\lambda$$

$$Z_g = K \int X_e(\lambda) I_R(\lambda) S_G(\lambda) z(\lambda) d\lambda$$

$$K = 100 / \int X_e(\lambda) I_R(\lambda) y(\lambda) d\lambda$$

wherein

Xe ( $\lambda$ ): spectral emission characteristics of a Xe tube;  
IR ( $\lambda$ ): spectral transmission characteristics of an infrared cut-off filter;  
SG ( $\lambda$ ): spectral sensitivity characteristics of

x, y, z ( $\lambda$ ): a single G sensor;  
color matching functions.

[0030] SG ( $\lambda$ ), Xe ( $\lambda$ ) and IR ( $\lambda$ ) have characteristics as respectively shown in Figs. 12 to 14. Also the tristimulus values Xr, Yr, Zr of the R sensor and those Xb, Yb, Zb of the B sensor can be similarly determined by replacing, in the foregoing equations, the spectral sensitivity characteristics SG ( $\lambda$ ) of the single G sensor with that SR ( $\lambda$ ) of the single R sensor and with that SB ( $\lambda$ ) of the single B sensor.

[0031] The CIE-xy chromaticity coordinates of the G sensor can be determined by substituting the tristimulus values Xg, Yg, Zg, obtained from the foregoing equations, into following equations:

$$xg = Xg / (Xg + Yg + Zg)$$

$$yg = Yg / (Xg + Yg + Zg)$$

[0032] The xy chromaticity coordinates xr, yr of the R sensor and those xb, yb of the B sensor can also be determined in a similar manner.

[0033] The sensor chips are classified, for example, into two groups A and B, according to thus determined xy chromaticity of G sensor as shown in Fig. 11. The difference in chromaticity of the G sensors arises only from the difference in the spectral sensitivity characteristics of each G sensor, since other components are common in a contact multi-chip color image sensor.

[0034] For the simplicity of explanation, let us assume that the R or B sensors have the identical chromaticity characteristics. In such case, the G sensors of chips, respectively selected from the groups A and B, will show color spaces as shown in Fig. 15 as an example. Consequently, if the sensor array is constructed without such grouping, the sensor chips having both color spaces A, B may be mixedly present within a sensor array.

[0035] As a result, a picture element of a chromaticity C1 will be reproduced differently as C1A and C1B, respectively by the sensor chips of the color spaces A and B, though there exists only one original color. As the picture elements within a sensor chip provide relatively uniform chromaticity in reproduction, the difference in the chromaticity characteristics between the sensor chips appears as a color step difference on the reproduced image.

[0036] Therefore, by constituting the sensor array from the sensor chips belonging only to a group, such sensor chips have relatively similar color spaces, so that it is made possible to reduce the difference in color characteristics among the sensor chips and to reduce the color step difference.

[0037] In practice, however, it is not enough to classify the sensor chips according to the chromaticity characteristics of the G sensors only, because the spectral sen-

sitivity characteristics of the sensor chips show fluctuation not only in the G sensors but also in the R and B sensors. For this reason, in the present embodiment, the grouping is also conducted for the R and B sensors by calculating the xy chromaticity coordinates thereof, as in the case of G sensors, and each sensor array is constituted by the sensor chips which belong to a same group of classification for three colors, whereby the color spaces of the sensor chips are made mutually close.

[0038] Fig. 16 shows the ranges of fluctuation of the xy chromaticity of the R, G, B sensors among the sensor chips and the ranges of grouping thereof. Fig. 17 shows the distribution of xy chromaticity of the B sensors in 10 sensor chips and the grouping thereof, and Fig. 18 similarly shows the distribution of xy chromaticity of the R sensors in 10 sensor chips. By dividing the R and G sensors respectively in two groups and the B sensors into four groups, the sensor chips are classified into 16 groups of different chromaticity characteristics according to the combination of R, G and B. By constructing each sensors array from the sensor chips belonging only to a group selected from so many groups, the color spaces of the constituting sensor chips are made even closer and the color step difference can be securely reduced.

[0039] As explained in the foregoing, it is rendered possible to provide a contact multi-chip color image sensor capable of image reading with highly uniform color characteristics over the entire pixel area, by classifying the sensor chips, constituting said image sensor, into plural groups according to the similarity of the color reproducible area of each sensor chip and constructing each sensor array with the sensor chips belonging only to a group.

[0040] In the present embodiment, the grouping of the sensor chips is conducted according to the color reproducible area of such sensor chips in the CIE 1931 standard colorimetric system, but a similar grouping may be conducted in other color space such as CIELAB color space or CIE LUV space. Also such concept is naturally applicable to other similar color image sensors such as of filter switching type or rotating prism type.

[0041] Fig. 19 is a cross-sectional view of a contact multi-chip color image sensor constituting a third embodiment. The foregoing second embodiment discloses an image sensor provided with color filters, but the present embodiment describes an image sensor of light source switching type.

[0042] The color image sensor of light source switching type is composed of monochromatic sensor chips without color filters and light sources of three colors, wherein the color information is obtained from the output signals of the monochromatic sensor chips when the light sources of three colors are alternately turned on in a position on the original image. The present embodiment employs LED's of R, G and B colors, but there may also be employed other colors or other light sources. In Fig. 19 there are shown a sensor array 1' consisting of

an array of monochromatic sensor chips without color filters; a frame 200; an LED 221; and an LED board 220 on which LED's are mounted.

[0043] As shown in Fig. 20, the LED's 221 consist of those 221R, 221G, 221B respectively of R, G and B colors, which are arranged in a linear array and those of each color can be independently turned on and off. The light 222 emerging from the LED's 221 illuminates a face of the original placed in contact with the upper face of a transparent glass plate 201, and the light 223 reflected from the image-bearing face of the original enters the sensor array 1', provided on a board 19, through an optical system 209. As shown in Fig. 21, the sensor array 1' is composed of sensor chips 22, 22', ..., each of which is provided with a linear array of apertures 24 which are not provided with color filters and which are mutually separated by an element separating area 26 and light shielding areas 7.

[0044] Also in such contact multi-chip color image sensor of light switching type, the color space can be determined as in the foregoing second embodiment. For example, the tristimulus values Xg, Yg, Zg of G color can be obtained from:

$$Xg = K \int LG(\lambda) S(\lambda) x(\lambda) d\lambda$$

$$Yg = K \int LG(\lambda) S(\lambda) y(\lambda) d\lambda$$

$$Zg = K \int LG(\lambda) S(\lambda) z(\lambda) d\lambda$$

$$K = 100 / \int D65(\lambda) y(\lambda) d\lambda$$

wherein

LG( $\lambda$ ): spectral emission characteristics of GLED;  
 S( $\lambda$ ): spectral sensitivity characteristics of a single monochromatic sensor;  
 D65( $\lambda$ ): spectral emission characteristics of a standard D65 light source;  
 x, y, z( $\lambda$ ): color matching functions of CIE 1931 standard colorimetric system.

[0045] S( $\lambda$ ) and LG( $\lambda$ ) have characteristics as respectively shown in Figs. 22 and 23. Also the tristimulus values Xr, Yr, Zr of R color and those Xb, Yb, Zb of B color can be similarly determined by replacing, in the foregoing equations, the spectral emission characteristics LG( $\lambda$ ) of the GLED with those LR( $\lambda$ ) of RLED and those LB( $\lambda$ ) of BLEED.

[0046] The CIE-xy coordinates of the G color can be determined by substituting the tristimulus values Xg, Yg, Zg, obtained from the foregoing equations, into following equations:

$$xg = Xg / (Xg + Yg + Zg)$$

$$yg = Yg / (Xg + Yg + Zg)$$

[0047] The xy coordinates xr, yr of the R color and those xb, yb of the B color can also be determined in a similar manner.

[0048] Also in the color image sensor of light source switching type, the R, G, B chromaticity coordinates, defining the color spaces, can be determined according to the above-explained procedure. Thus, by measuring the spectral sensitivity characteristics of each monochromatic sensor chip and classifying the sensor chips according to thus calculated chromaticity coordinates, it is rendered possible to construct each contact multi-chip color image sensor only with the sensor chips of similar chromaticity characteristics as in the second embodiment and to improve the quality of the read image.

[0049] It is thus rendered possible to provide a contact multi-chip color image sensor capable of image reading with highly uniform color characteristics over the entire pixel area, by classifying the sensor chips, constituting the image sensor, into plural groups according to the similarity of the color reproducible area of each sensor chip and constructing each sensor array with the sensor chips belonging only to a group.

#### Claims

1. An image sensor for converting the light from an object into an electrical signal,  
 wherein said image sensor comprises a plurality of spaced apart picture elements aligned with one another in a longitudinal direction, each picture element consisting of plural pixel sensors (R,G,B) arranged in the same longitudinal direction, and **characterised in that** said picture elements are arranged so that the separating area between respective picture elements has a width larger than the distance between the centers of adjacent sensors within a picture element.
2. A sensor according to claim 1, wherein each of said picture elements is composed of plural pixel sensors of mutually different colors.
3. A sensor according to claim 2, wherein each picture element is composed of three pixel sensors of red, green and blue colors.
4. A sensor according to any preceding claim, wherein said image sensor is composed of plural sensor chips (2, 21) each chip including a plurality of picture elements.

5. A sensor according to any preceding claim, further comprising an optical system for focussing the image light from said object onto said image sensor, wherein, in said image sensor, the picture elements are arranged with a pitch resolvable by said optical system and the groups of pixel sensors within an picture element are arranged with such a pitch as to lower the resolution by said optical system. 5
6. A sensor according to claim 2 or any one of claims 3 to 5 when dependent on claim 2, wherein pixel sensors which show the largest relative difference in the spectral sensitivity characteristics with respect to a color, are not placed in mutually adjacent positions. 10
7. A sensor according to claim 1, wherein each of said picture elements is composed of plural monochromatic pixel sensors and the image of an object is taken by switching plural light sources of different colors. 15

#### Patentansprüche

1. Bildsensor zur Umwandlung des Lichtes von einem Objekt in ein elektrisches Signal, wobei der Bildsensor eine Vielzahl von voneinander beabstandeten und in longitudinaler Richtung miteinander ausgerichteten Bildelementen aufweist, dabei umfasst jedes Bildelement viele in derselben longitudinalen Richtung angeordnete Bildpunktsensoren (R, G, B), **dadurch gekennzeichnet, dass** die Bildelemente so angeordnet sind, dass der Trennbereich zwischen jeweiligen Bildelementen eine größere Breite als der Abstand zwischen den Zentren benachbarter Sensoren innerhalb eines Bildelementes aufweist. 25
2. Sensor nach Anspruch 1, wobei jedes der Bildelemente aus vielen Bildpunktsensoren mit voneinander verschiedenen Farben zusammengesetzt ist. 30
3. Sensor nach Anspruch 2, wobei jedes Bildelement aus drei Bildpunktsensoren der Farben Rot, Grün und Blau zusammengesetzt ist. 35
4. Sensor nach einem der vorstehenden Ansprüche, wobei der Bildsensor aus vielen Sensorchips (2, 21) zusammengesetzt ist, wobei jeder Chip eine Vielzahl von Bildelementen beinhaltet. 40
5. Sensor nach einem der vorstehenden Ansprüche, zudem mit einem optischen System zum Fokussieren des Bildlichts von dem Objekt auf den Bildsensor, wobei bei dem Bildsensor die Bildelemente mit einem durch das optische System auflösbaren Maß 45

angeordnet sind, und die Bildpunktsensorgruppen innerhalb eines Bildelementes sind mit einem derartigen Maß angeordnet, damit die Auflösung durch das optische System verringert wird.

6. Sensor nach Anspruch 2 oder einem der Ansprüche 3 bis 5 sofern diese von Anspruch 2 abhängen, wobei Bildpunktsensoren mit der größten relativen Differenz bei den spektralen Empfindlichkeitseigenschaften bezüglich einer Farbe nicht an zueinander benachbarten Positionen angeordnet sind. 50
7. Sensor nach Anspruch 1, wobei jedes der Bildelemente aus vielen monochromatischen Bildpunktsensoren zusammengesetzt ist und das Bild eines Objekts durch das Schalten von vielen Lichtquellen verschiedener Farben aufgenommen wird. 55

#### Revendications

1. Capteur d'image destiné à convertir la lumière provenant d'un objet en un signal électrique, dans lequel ledit capteur d'image comporte plusieurs éléments d'image espacés alignés les uns avec les autres dans une direction longitudinale, chaque élément d'image consistant en plusieurs capteurs de pixels (R, G, B) agencés dans la même direction longitudinale, et **caractérisé en ce que** lesdits éléments d'image sont agencés de façon que la zone de séparation entre des éléments d'image respectifs ait une largeur plus grande que la distance entre les centres de capteurs adjacents dans un élément d'image. 25
2. Capteur selon la revendication 1, dans lequel chacun desdits éléments d'image est composé de plusieurs capteurs de pixels de couleurs mutuellement différentes. 30
3. Capteur selon la revendication 2, dans lequel chaque élément d'image est composé de trois capteurs de pixels des couleurs rouge, verte et bleue. 35
4. Capteur selon l'une quelconque des revendications précédentes, dans lequel ledit capteur d'image est composé de plusieurs puces de capteurs (2, 21), chaque puce comprenant plusieurs éléments d'image. 40
5. Capteur selon l'une quelconque des revendications précédentes, comportant en outre un système optique destiné à focaliser la lumière d'image provenant dudit objet sur ledit capteur d'image, dans lequel, dans ledit capteur d'image, les éléments d'image sont agencés à un pas pouvant être résolu par ledit système optique et les groupes de capteurs de pixels à l'intérieur d'un élément d'image 45

sont agencés à un pas tel qu'il diminue la résolution par ledit système optique.

6. Capteur selon la revendication 2 ou l'une quelconque des revendications 3 à 5, lorsqu'elle dépend de la revendication 2, dans lequel des capteurs de pixels qui présentent la plus grande différence relative de caractéristiques de sensibilité spectrale par rapport à une couleur ne sont pas placés dans des positions mutuellement adjacentes. 5 10
7. Capteur selon la revendication 1, dans lequel chacun desdits éléments d'image est composé de plusieurs capteurs de pixels monochromes et l'image d'un objet est prise par la commutation de plusieurs sources de lumière de différentes couleurs. 15

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FIG. 1

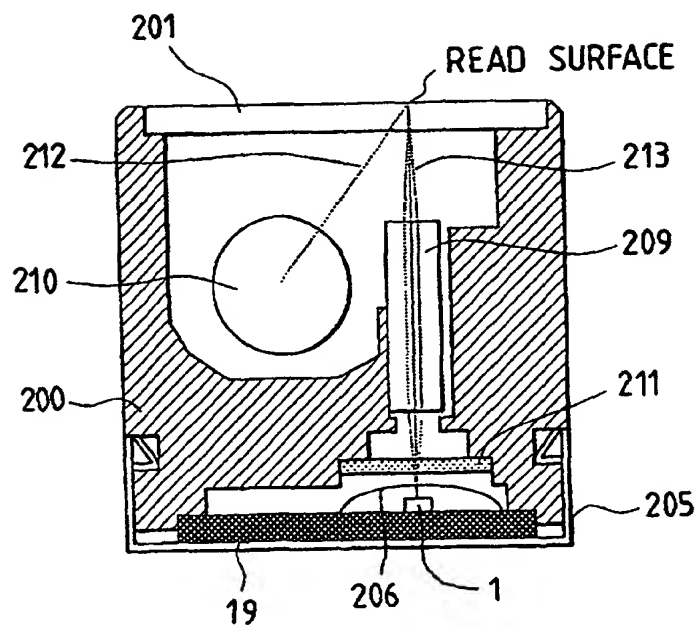


FIG. 2

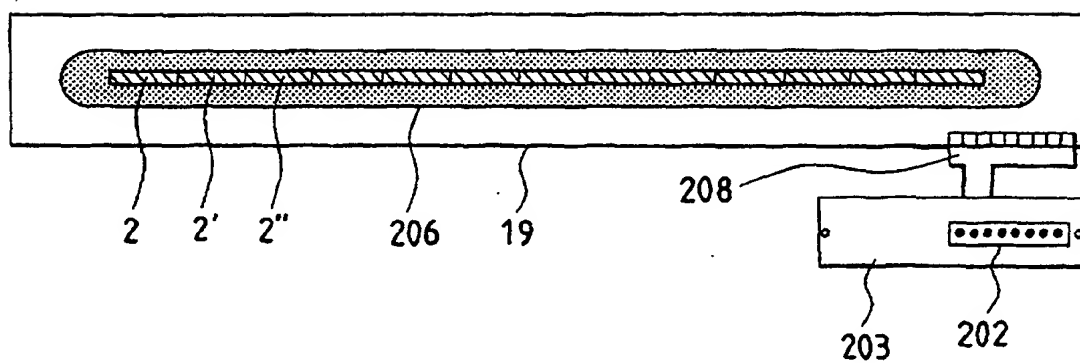


FIG. 3

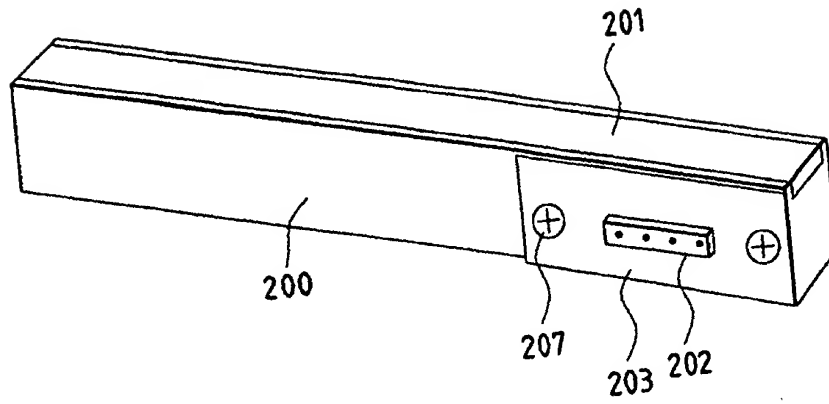
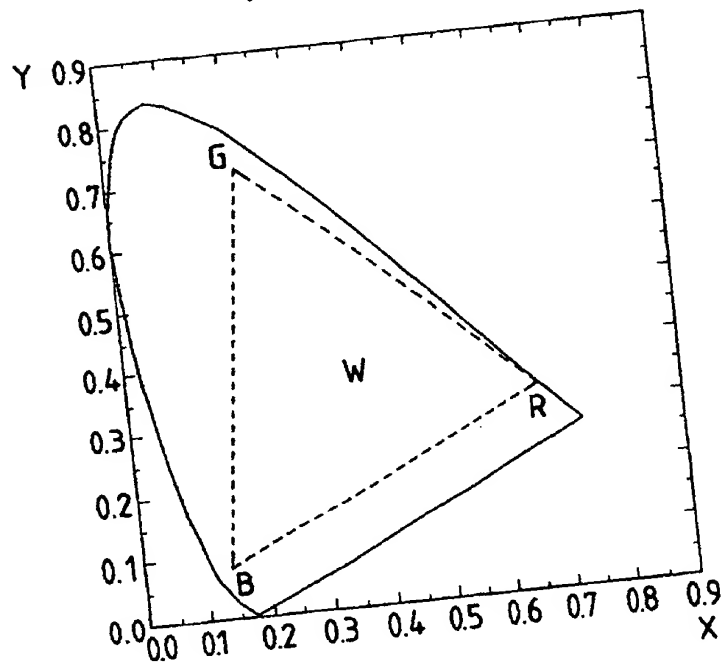


FIG. 5



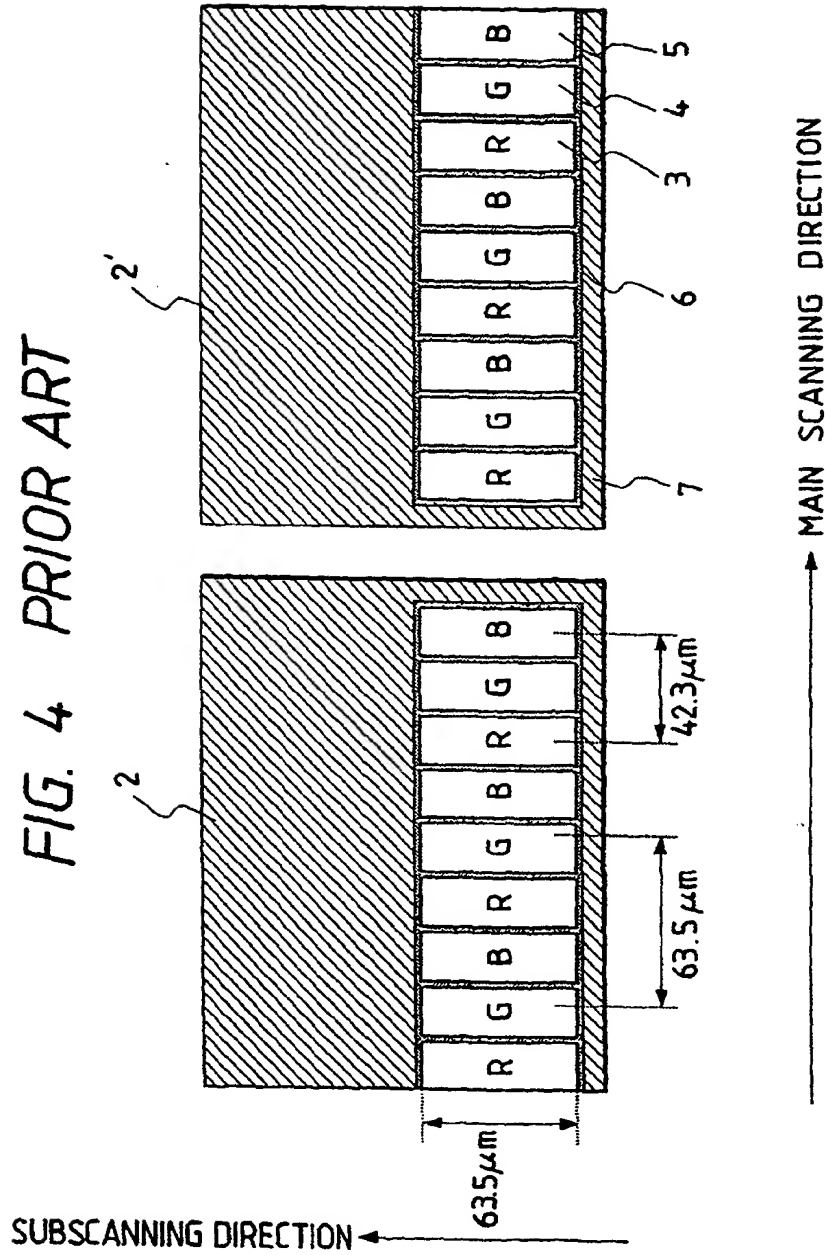


FIG. 6

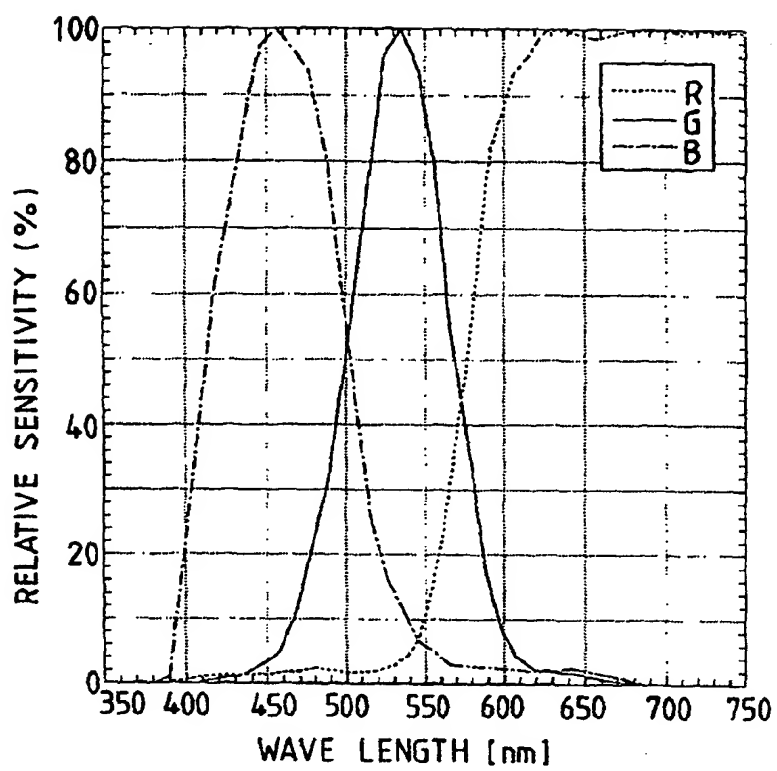


FIG. 7

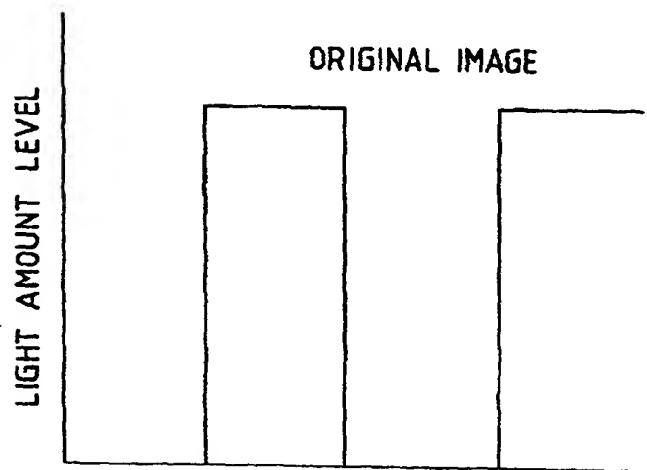


FIG. 8

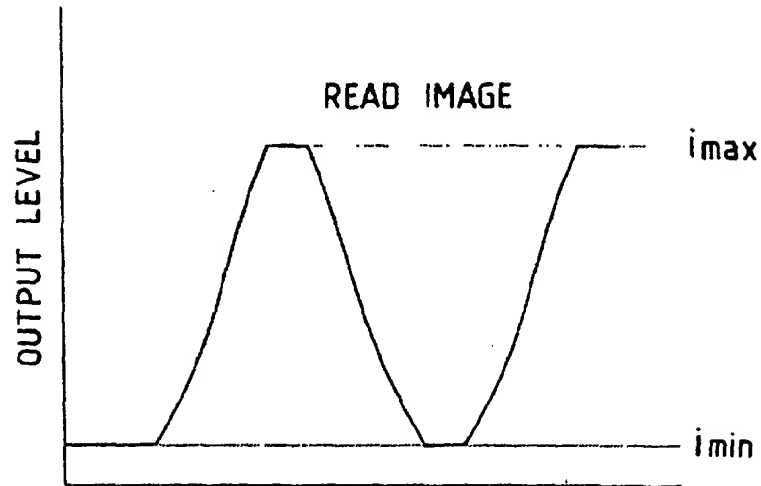
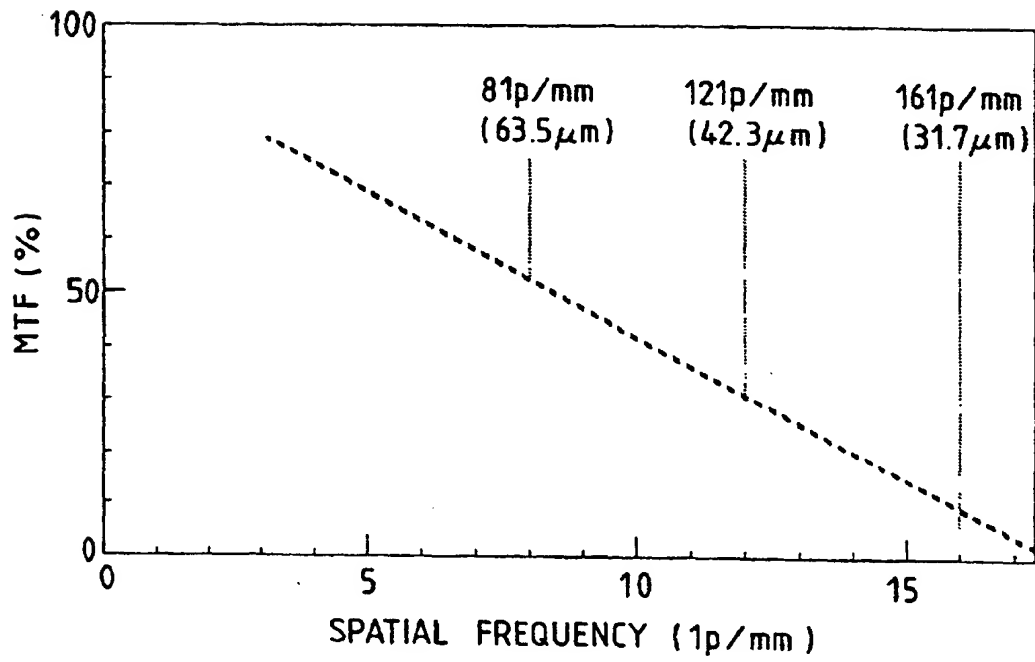


FIG. 9



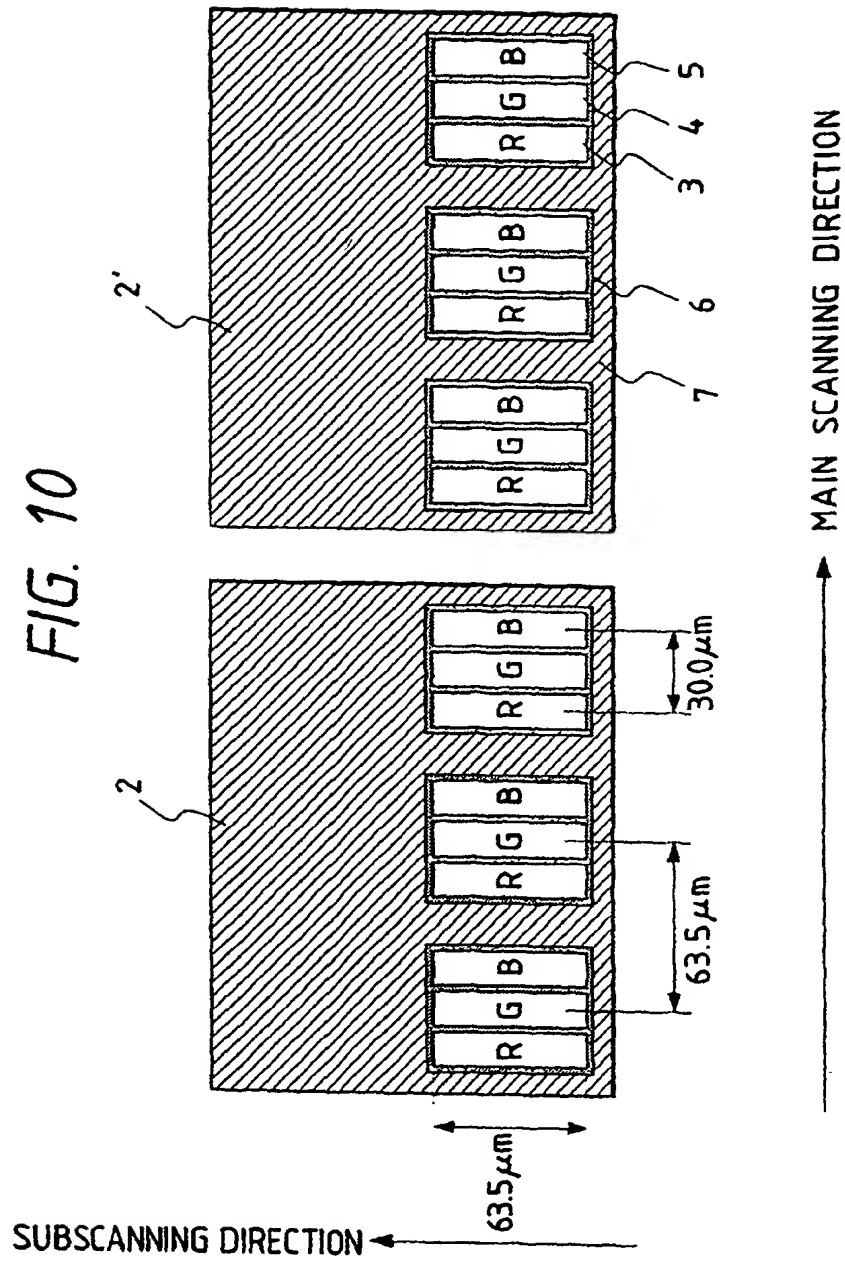


FIG. 11

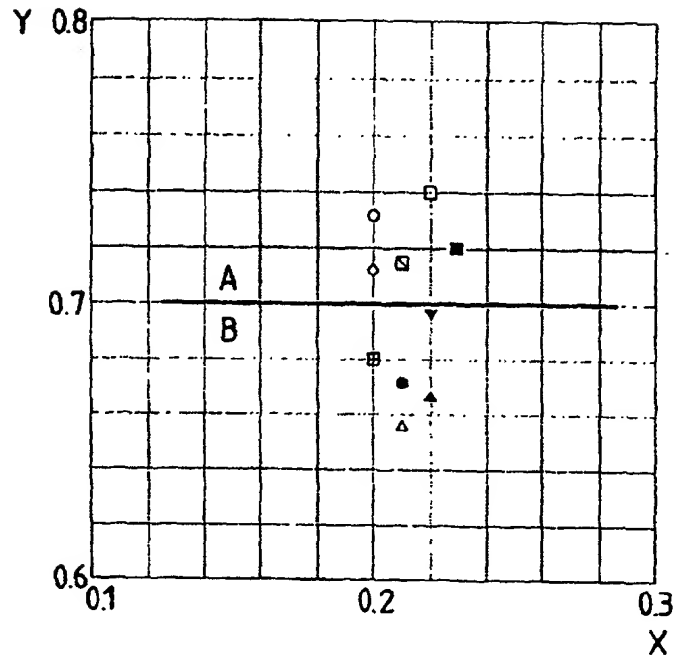


FIG. 12

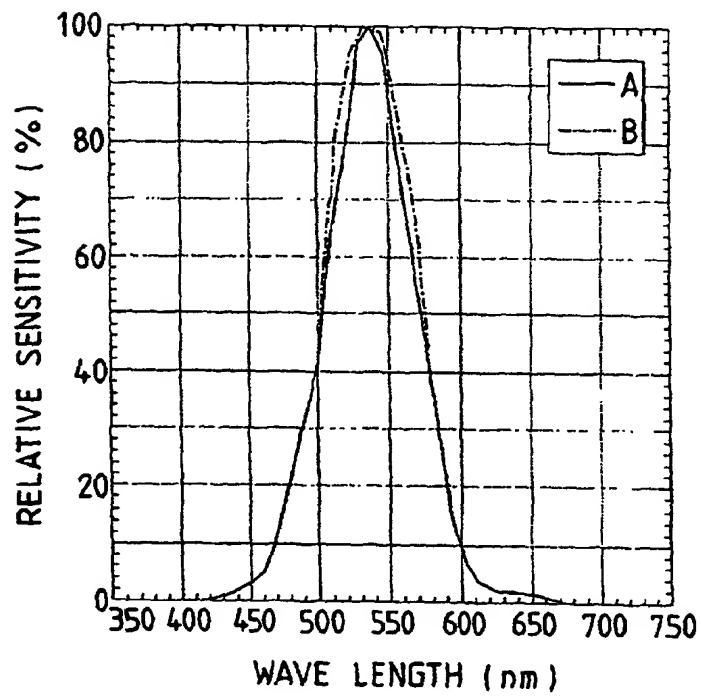


FIG. 13

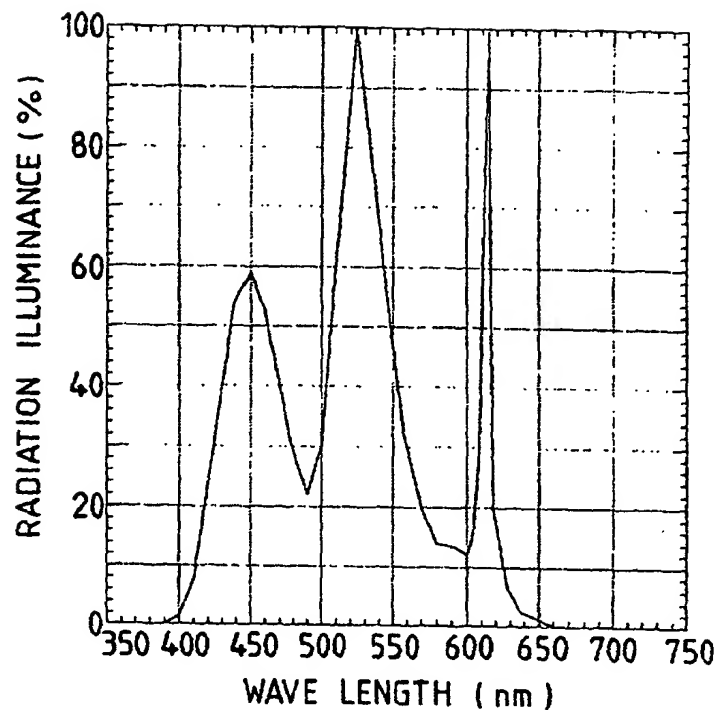


FIG. 14

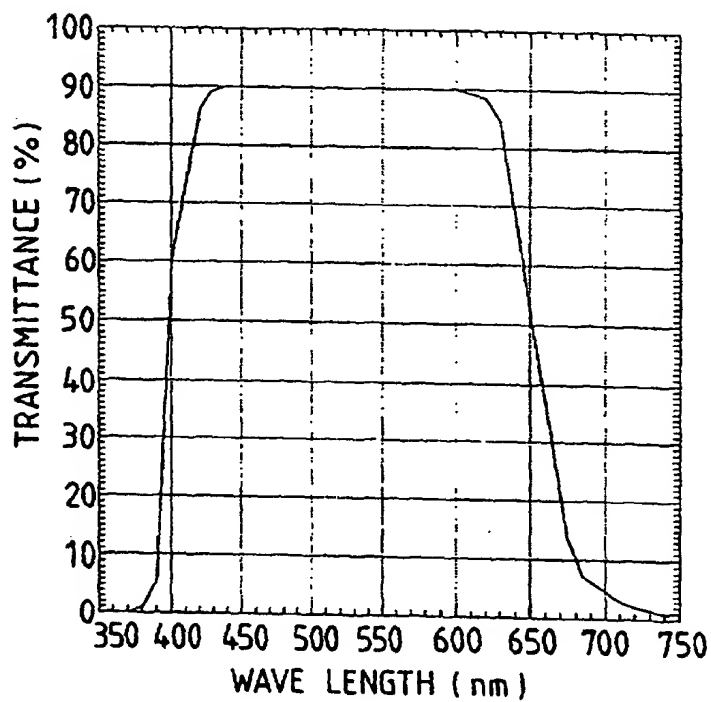


FIG. 15

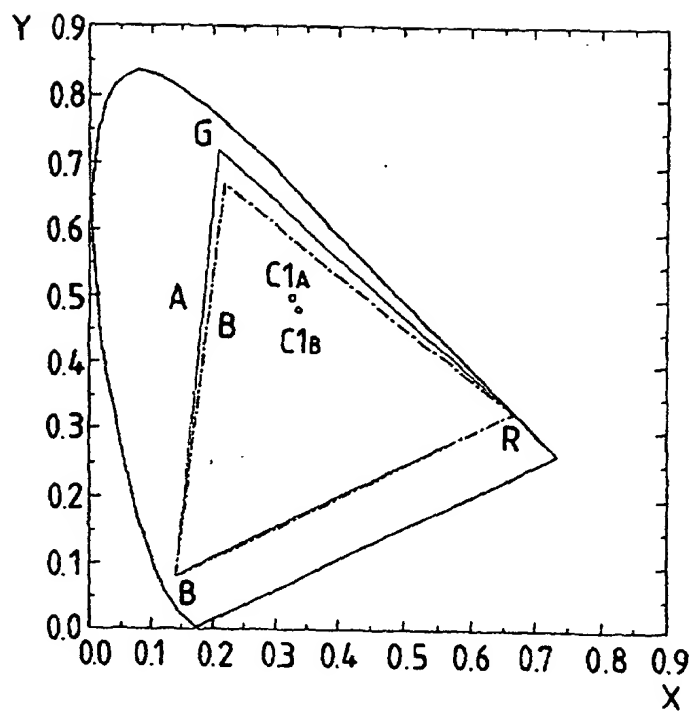


FIG. 16

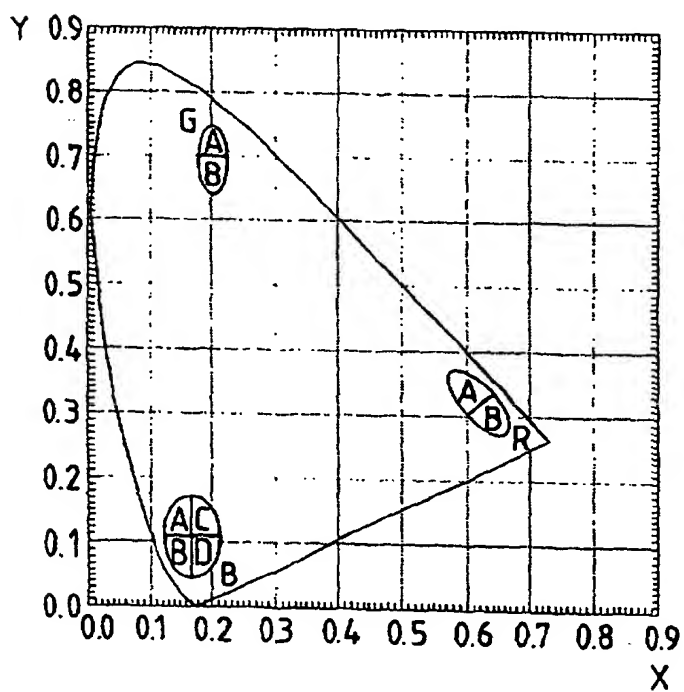


FIG. 17

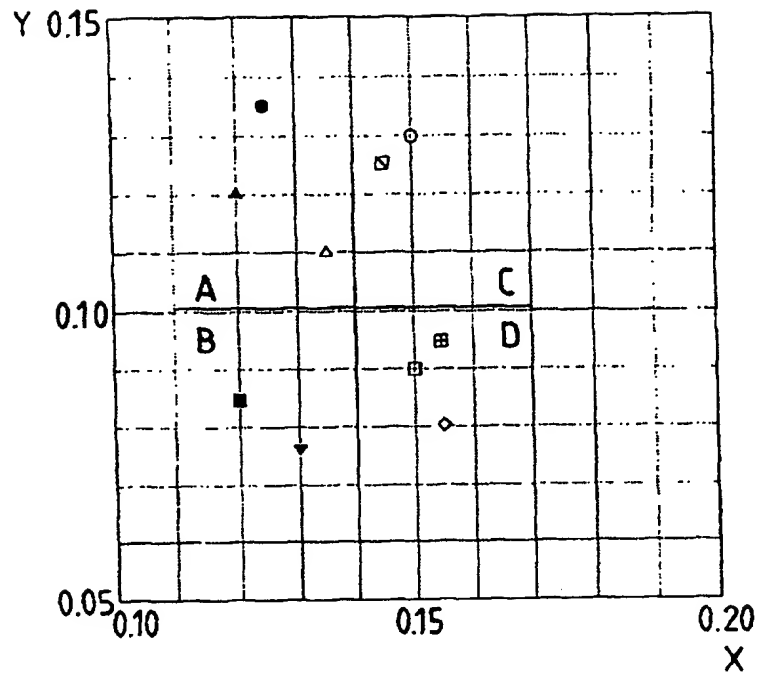


FIG. 18

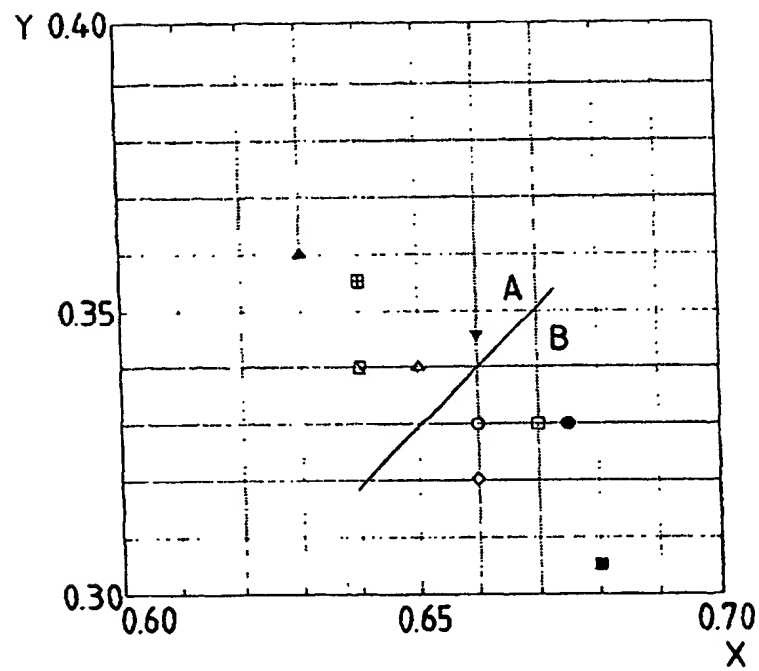


FIG. 19

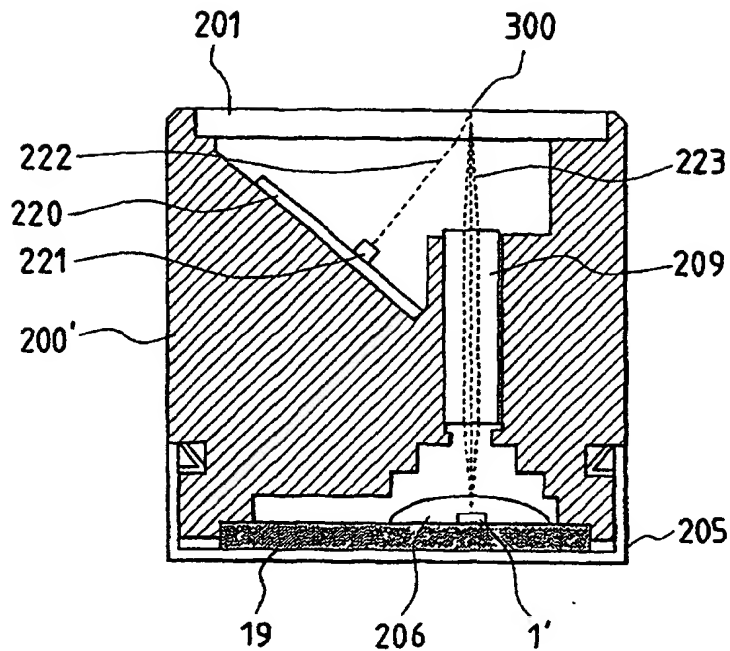


FIG. 20

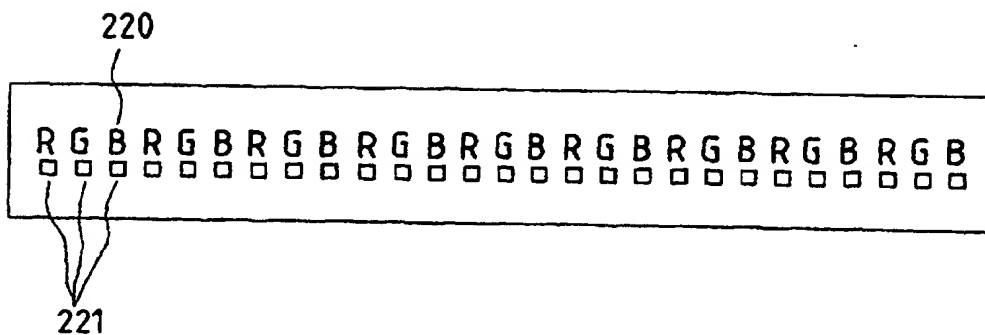


FIG. 21

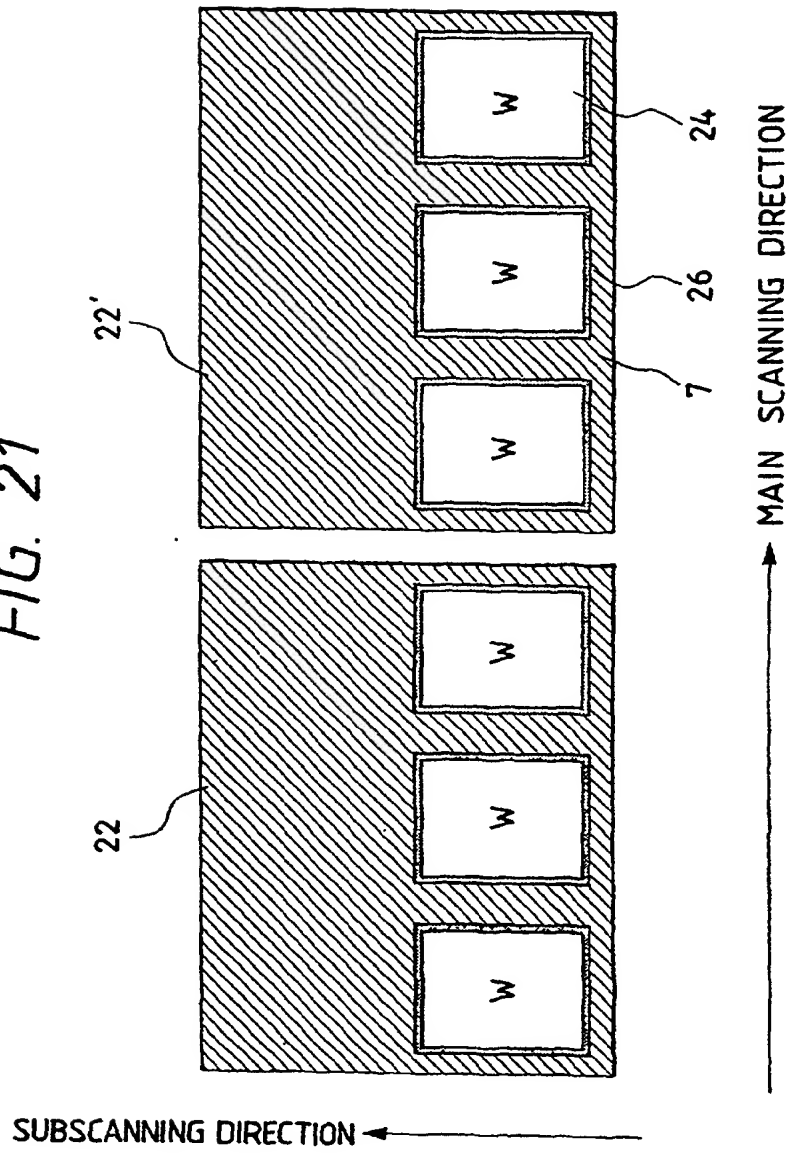


FIG. 22

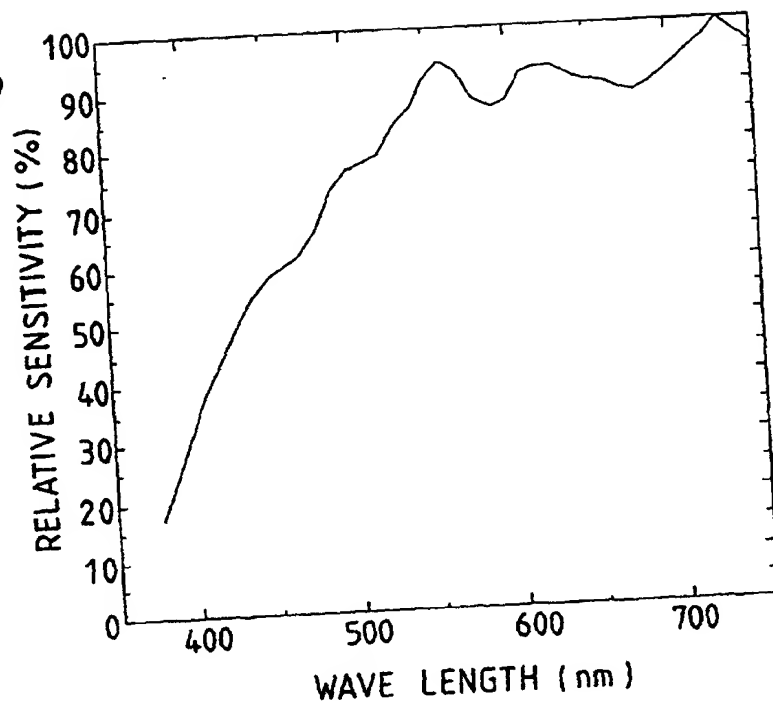


FIG. 23

